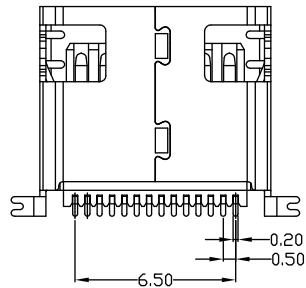


Recommended PCB Layout



MATERIAL:

Housing: LCP
 Shell: Copper Alloy
 Terminal: Copper Alloy

ELECTRICAL:

Signal Contact Current Rating: .30 AMPS
 Signal Contact Resistance: 40.0 milliohms MAX.
 Dielectric Withstanding Voltage: 500 VAC For 1 Minute
 Insulation Resistance: 1000 Megaohms
 Operating Temperature Range : -55°C ~ 85°C

HOW TO ORDER:

U 0 0 3 - T B H 0 - 2 7 X - Z X

SELECTIVE CONTACT PLATING

- 1 - Au Flash
- 2 - 30u" Au Over Ni

RoHS
COMPLIANT

PACKAGING

- 1- Tray
- 2- Tube w/out Cap
- 4 - T/R w/out Cap

Rev	Drawn	Checked	Approved	Date
0 Issued	B.S.	S.M.	S.M.	02/27/13

SMP TECHNOLOGY, INC.

Mini USB Receptacle; Right Angle; 14 Position; Surface Mount

TOL. DEC. .X +/- 0.3 .XX +/- 0.25 .XXX +/- 0.15 ANGLE +/- 2° UNIT: mm

U003-TBH0-27X-ZX